

SURFACE MOUNT FAST RECOVERY RECTIFIER

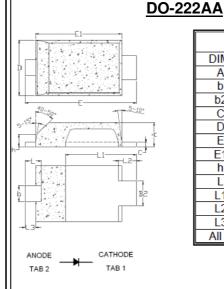
REVERSE VOLTAGE - 600 Volts FORWARD CURRENT - 1 Ampere

FEATURES

- Very low profile package 0.80mm
- · High efficiency
- Low forward voltage drop, low power loss
- For use in low voltage, high frequency inverters, free wheeling, dc-to-dc converters and polarity protection applications

MECHANICAL DATA

- Case: JEDEC DO-222AA
- Case Material: "Green" molding compound, UL flammability classification 94V-0, (No Br. Sb. Cl.)
- Terminals: Lead Free Plating (Matte Tin Finish.)
- Component in accordance to RoHs 2002/95/EC



DO-222AA					
DIM.	MIN.	MAX.			
Α	0.80	0.95			
b	0.40	0.65			
b2	0.70	1.00			
С	0.10	0.25			
D	1.75	2.05			
Е	3.60	3.90			
E1	2.80	3.10			
h	0.35	0.50			
L	0.50	0.80			
L1	2.10	2.60			
L2	0.45	0.75			
L3	0.20	0.50			
All Dimension in millimeter					

Maximum Ratings & Thermal Characteristics @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	FES1JM	Units
DC reverse voltage	V_R	600	V
Average Rectified Forward Current	Ιο	1	Α
Peak Forward Surge Current Single half sine-wave @tp=8.3ms	I _{FSM}	30	Α
Operating Temperature Range	TJ	-55 to +125	$^{\circ}\mathbb{C}$
Storage Temperature Range	T _{STG}	-55~+150	$^{\circ}\!\mathbb{C}$

Electrical Characteristics @ T_A = 25 °C unless otherwise specified

Characteristic	Test Condition	Symbol	FES1JM	Unit
Maximum Forward Voltage	$I_F = 1A$	V_{F}	1.3	V
Maximum DC Reverse Current @TJ=25 ℃ at Rated DC Blocking Voltage @TJ=125℃	V _R = 600V	I _R	5 200	uA
Maximum Reverse Recovery Time	(Note 1)	T_RR	35	ns
Typical Junction Capacitance	(Note 2)	Cj	20	pF

Thermal Characteristics @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур.	Max.	Unit
Typical thermal resistance Junction to Case (Note 3) Junction to Lead (Note 3)	RthJC RthJL	-	-	15 35	°C/W

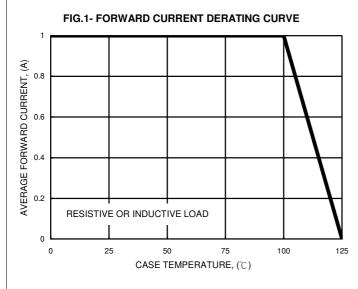
Note: (1) Reverse Recovery Test Condition:I_F=0.5A,I_R=1.0A,I_{RR}=0.25A

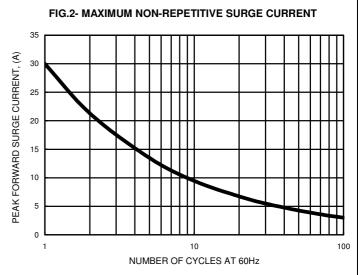
- (2) Measured at 1.0MHz and applied reverse voltage of 4.0V DC
- (3) Thermal Resistance test performed in accordance with JESD-51. Unit mounted on glass-epoxy substrate with 1oz/ft²_5 x 7mm copper pad.

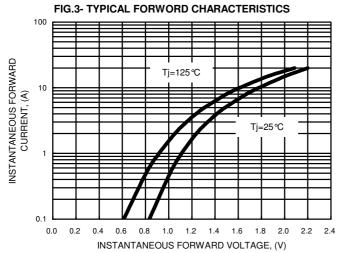
REV. 0, Nov-2013, KSEP04

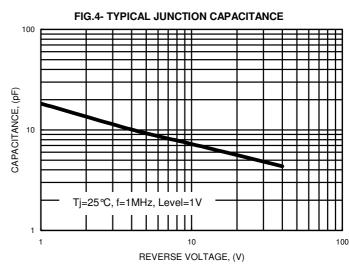
RATING AND CHARACTERISTIC CURVES FES1JM

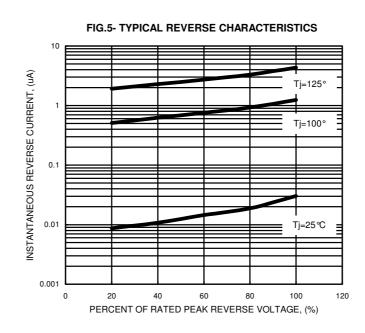










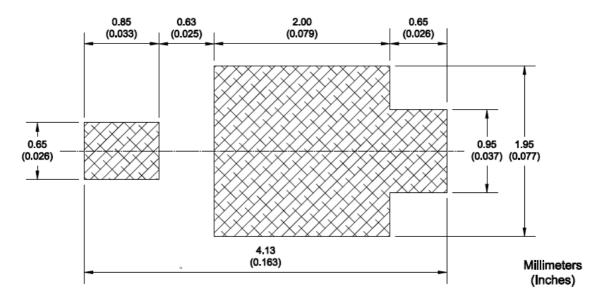




Device P/N Marking Equivalent Circuit Diagram

FES1JM E1J

Fig.6 Recommended Foot Print of DO-222AA with Mite Flat





Important Notice and Disclaimer

LSC reserves the right to make changes to this document and its products and specifications at any time without notice. Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.

LSC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does LSC assume any liability for application assistance or customer product design. LSC does not warrant or accept any liability with products which are purchased or used for any unintended or unauthorized application.

No license is granted by implication or otherwise under any intellectual property rights of LSC.

LSC products are not authorized for use as critical components in life support devices or systems without express written approval of LSC.